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Appl. No. 10/563,778

Request for Corrected Assignment dated 10/19/2006

Attorney Docket No. 1217-053827

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.

10/563.778

Confirmation No. 3140

**Applicants** 

Naoya SAIKI

Filed

January 6, 2006

Title

Hardenable Pressure Sensitive Adhesive Sheet for Dicing/Die-

Bonding and Method for Manufacturing Semiconductor Device

Art Unit

1734

Customer No.

28289

FACSIMILE NO. 703-305-9822 Office of Initial Patent Examination's Filing Receipt Corrections Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

### REQUEST FOR CORRECTED FILING RECEIPT

Sir:

Attached is a marked-up copy of the official Filing Receipt for the aboveidentified patent application for which a Corrected Filing Receipt is hereby requested.

The Foreign Applications data is missing. It should include the following Japanese Application Information

--Japan 2003-271950 07/08/2003--

A copy of the Declaration and Power of Attorney for Patent Application filed with the application on January 6, 2006 listing the complete Foreign Priority Information is also attached. No fee is due, as there was no error on the Applicant's part.

> Respectfully submitted. THE WEBB LAW FIRM

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on October 19, 2006.

Michael L. Vertullo

(Name of Person Mailing Paper)

0/19/2006

Kent E. Baldauf

Registration No. 25,826

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# United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address COMMISSIONER POR PATENTS P.O. Box 1430 Alexandria, Viginia 22313-1430

APPL NO. | FILING OR 371 | ART UNIT | FIL FEE REC'D | ATTY.DOCKET NO | DRAWINGS | TOT CLMS | IND CLMS | 10/563,778 | 01/06/2006 | 1734 | 900 | 1217-053827 | 17 | 1

28289 THE WEBB LAW FIRM, P.C.

THE WEBB LAW FIRM, P.C. 700 KOPPERS BUILDING 436 SEVENTH AVENUE

PITTSBURGH, PA 15219

**CONFIRMATION NO. 3140** 

FILING RECEIPT

\*\*OC00000019854061\*

Date Mailed: 08/02/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Naoya Saiki, Saitama, JAPAN;

**Assignment For Published Patent Application** 

Lintec Corporation, Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 28289.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/09629 07/07/2004

Foreign Applications JAPAN 2003-27/950 08/07/2003

If Required, Foreign Filing License Granted: 08/01/2006

The country code and number of your priority application, to be used for filing abroad under the Parls Convention, is US10/563,778

Projected Publication Date: 11/09/2006

Non-Publication Request: No

Early Publication Request: No

RECEIVED
THE WEBB LAW FIRM

AUG - 7 2006

Title

Hardenable pressure sensitive adhesive sheet for dicing/die-bonding and method for manufacturing semiconductor device

Preliminary Class

156

## PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process simplifies the filing of patent applications on the same invention in member countries, but does not result in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

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Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at http://www.uspto.gov/web/offices/pac/doc/general/index.html.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, http://www.stopfakes.gov. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

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Title 37, Code of Federal Regulations, 5.11 & 5.15

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# Declaration and Power of Attorney for Patent Application

# English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a

e sp	ESIVE SHEET AND PROCESS FOR PRODUCING exification of which							
	is attached hereto.							
	was filed on							
	as Application Serial No.							
	and was amended on	_						
(	(if applicable) was filed as PCT international application							
	No. <u>PCT/JP2004/9629</u> on	July 7, 2004	<u> </u>	<u> </u>				
	and was amended under PCT Article 19 on							
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acknoccorda hereboplicate policate riority rior Fo	ing the claims, as amended by any amendment referred to all owledge the duty to disclose information which is material ance with Title 37, Code of Federal Regulations, §1.56(a).  by claim foreign priority benefits under Title 35, Unitation(s) for patent or inventor's certificate listed below and the strong for patent or inventor's certificate having a filing date of its claimed:  foreign Application(s)    1950   Japan   08/July/2003	to the patentabilitied States Code, have also identify before that of the Year Filed)	§119 of fied below a application  Priori  Yes	any foreign any foreign any foreign on on which ty Claimed No				

Code, §112. I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Page 2

(Application Scriel No.)	(Filing Date)	(Status) (patented, pending, abundoned)
(Application Scrial No.)	(Filing Date)	(Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY:

As a named inventor, I hereby appoint the practitioners associated with

#### **Customer Number 28289**

to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith.

Customer Number 28289 identifies the law firm of WEBB ZIESENHEIM LOGSDON ORKIN AND HANSON, P.C. whose address is 700 Koppers Building, 436 Seventh Avenue, Pittsburgh, Pennsylvania 15219-1818, Telephone No. 412-471-8815

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Inventor's signature	Date			
Residence				
Citizenship				
Post Office Address	-	_	· · · · · · · · · · · · · · · · · · ·	

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